DS75160A,DS75161A

DS75160A/DS75161A IEEE-488 GPIB Transceivers



Literature Number: SNOSBL5A



DS75160A/DS75161A IEEE-488 GPIB Transceivers

General Description

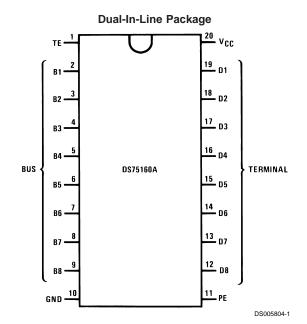
This family of high-speed-Schottky 8-channel bi-directional transceivers is designed to interface TTL/MOS logic to the IEEE Standard 488-1978 General Purpose Interface Bus (GPIB). PNP inputs are used at all driver inputs for minimum loading, and hysteresis is provided at all receiver inputs for added noise margin. The IEEE-488 required bus termination is provided internally with an active turn-off feature which disconnects the termination from the bus when $V_{\rm CC}$ is removed.

The General Purpose Interface Bus is comprised of 16 signal lines — 8 for data and 8 for interface management. The data lines are always implemented with DS75160A, and the management lines are either implemented with DS75161A in a single-controller system.

Features

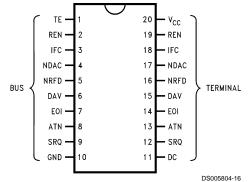
- 8-channel bi-directional non-inverting transceivers
- Bi-directional control implemented with TRI-STATE® output design
- Meets IEEE Standard 488-1978
- High-speed Schottky design
- Low power consumption
- High impedance PNP inputs (drivers)
- 500 mV (typ) input hysteresis (receivers)
- On-chip bus terminators
- No bus loading when V_{CC} is removed
- Pin selectable open collector mode on DS75160A driver outputs
- Accommodates multi-controller systems

Connection Diagrams



Top View
Order Number DS75160AWM
See NS Package Number M20B or N20A





Order Number DS75161AN or DS75161AWM See NS Package Number M20B or N20B

Absolute Maximum Ratings (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage, V_{CC} 7.0V Input Voltage 5.5V Storage Temperature Range -65° C to $+150^{\circ}$ C Lead Temperature (Soldering, 4 sec.) 260 $^{\circ}$ C

Molded Package 1897 mW Min Max Units V_{CC}, Supply Voltage 4.75 5.25 V T_A, Ambient Temperature 0 70 °C I_{OL}, Output Low Current Bus 48 mΑ Terminal 16 mΑ

Note 1: Derate molded package 15.2 mW/°C above 25°C.

Maximum Power Dissipation (Note 1) at 25°C

Electrical Characteristics (Notes 3, 4)

Symbol	Parame	ter	Conditions		Min	Тур	Max	Units
V _{IH}	High-Level Input Volta	ige			2			V
V _{IL}	Low-Level Input Voltage	ge					0.8	V
V _{IK}	Input Clamp Voltage		$I_1 = -18 \text{ m/s}$	4		-0.8	-1.5	V
V _{HYS}	Input Hysteresis	Bus			400	500		mV
V _{OH}	High-Level	Terminal	I _{OH} = -800	μΑ	2.7	3.5		V
	Output Voltage	Bus (Note 4)	$I_{OH} = -5.2$	mA	2.5	3.4		1
V _{OL}	Low-Level	Terminal	I _{OL} = 16 m	A		0.3	0.5	V
	Output Voltage	Bus	I _{OH} = 48 m	A		0.4	0.5	1
I _{IH}	High-Level	Terminal and	$V_1 = 5.5V$			0.2	100	μΑ
	Input Current	TE, PE, DC,	V _I = 2.7V			0.1	20	1
I _{IL}	Low-Level	SC Inputs	V ₁ = 0.5V			-10	-100	μΑ
	Input Current							
V _{BIAS}	Terminator Bias		Driver	I _{I(bus)} = 0 (No Load)	2.5	3.0	3.7	V
	Voltage at Bus Port		Disabled					
I _{LOAD}	Terminator			$V_{I(bus)} = -1.5V \text{ to } 0.4V$	-1.3			
	Bus Loading			$V_{I(bus)} = 0.4V \text{ to } 2.5V$	0		-3.2	1
	Current	Bus	Driver	V _{I(bus)} = 2.5V to 3.7V			2.5	mA
			Disabled				-3.2	
				V _{I(bus)} = 3.7V to 5V	0		2.5	
				$V_{I(bus)} = 5V \text{ to } 5.5V$	0.7		2.5	
			$V_{CC} = 0V$	$V_{I(bus)} = 0V \text{ to } 2.5V$			40	μA
Ios	Short-Circuit	Terminal	$V_1 = 2V$, $V_0 = 0V$ (Note 5)		-15	-35	-75	mA
	Output Current	Bus (Note 6)					-150	
I _{CC}	Supply Current	DS75160A	Transmit, TE = 2V, PE = 2V, $V_I = 0.8V$ Receive, TE = 0.8V, PE = 2V, $V_I = 0.8V$			85	125	
						70	100	mA
		DS75161A	TE = 0.8V,	$DC = 0.8V, V_1 = 0.8V$		84	125	
C _{IN}	Bus-Port	Bus	$V_{CC} = 5V \text{ or } 0V, V_I = 0V \text{ to } 2V,$			20	30	pF
	Capacitance		f = 1 MHz					

Note 2: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 3: Unless otherwise specified, min/max limits apply across the 0°C to +70°C temperature range and the 4.75V to 5.25V power supply range. All typical values are for $T_A = 25$ °C and $V_{CC} = 5.0$ V.

Note 4: All currents into device pins are shown as positive; all currents out of device pins are shown as negative; all voltages are referenced to ground, unless otherwise specified. All values shown as max or min are so classified on absolute value basis.

Note 5: Only one output at a time should be shorted.

Note 6: This characteristic does not apply to outputs on DS75161A that are open collector.

Switching Characteristics (Note 7) $V_{CC} = 5.0V \pm 5\%$, $T_A = 0^{\circ}C$ to $70^{\circ}C$

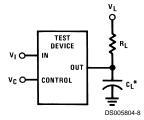
Symbol	Parameter	From	То	Conditions	DS75160A		60A	D	S7516	51A	DS75162A			Units
					Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	
t _{PLH}	Propagation Delay Time,			V _L = 2.3V		10	20		10	20		10	20	ns
	Low to High Level Output	Terminal	Bus	$R_L = 38.3\Omega$										
t _{PHL}	Propagation Delay Time,	1		$C_L = 30 pF$		14	20		14	20		14	20	ns
	High to Low Level Output			Figure 1										
t _{PLH}	Propagation Delay Time,			$V_{L} = 5.0V$		14	20		14	20		14	20	ns
	Low to High Level Output	Bus	Terminal	$R_L = 240\Omega$										
t _{PHL}	Propagation Delay Time,	1		$C_L = 30 pF$		10	20		10	20		10	20	ns
	High to Low Level Output			Figure 2										
t _{PZH}	Output Enable Time			$V_1 = 3.0V$		19	32		23	40		23	40	ns
	to High Level			$V_L = 0V$										
t _{PHZ}	Output Disable Time	TE, DC,		$R_L = 480\Omega$		15	22		15	25		15	25	ns
	From High Level	or SC		$C_L = 15 pF$										
				Figure 1										
t_{PZL}	Output Enable Time	(Note 8)	Bus	$V_I = 0V$		24	35		28	48		28	48	ns
	to Low Level	(Note 9)		$V_{L} = 2.3V$										
t _{PLZ}	Output Disable Time	1		$R_L = 38.3\Omega$		17	25		17	27		17	27	ns
	From Low Level			$C_L = 15 pF$										
				Figure 1										
t _{PZH}	Output Enable Time			V _I = 3.0V		17	33		18	40		18	40	ns
	to High Level			$V_L = 0V$										
t _{PHZ}	Output Disable Time	TE, DC,		$R_L = 3 \text{ k}\Omega$		15	25		22	33		22	33	ns
	From High Level	or SC	Terminal	$C_L = 15 pF$										
				Figure 1										
t _{PZL}	Output Enable Time	(Note 8)		$V_I = 0V$		25	39		28	52		28	52	ns
	to Low Level	(Note 9)		$V_L = 5V$										
t _{PLZ}	Output Disable Time	1		$R_L = 280\Omega$		15	27		20	35		20	35	ns
	From Low Level			$C_L = 15 pF$										
				Figure 1										
t _{PZH}	Output Pull-Up Enable			V _I = 3V		10	17		NA			NA		ns
	Time (DS75160A Only)	PE	Bus	$V_L = 0V$										
t _{PHZ}	Output Pull-Up Disable	(Note 8)		$R_L = 480\Omega$		10	15		NA			NA		ns
	Time (DS75160A Only)			$C_{L} = 15 \text{ pF}$										
				Figure 1										

Note 7: Typical values are for V_{CC} = 5.0V and T_A = 25°C and are meant for reference only.

Note 8: Refer to Functional Truth Tables for control input definition.

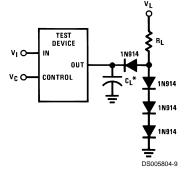
Note 9: Test configuration should be connected to only one transceiver at a time due to the high current stress caused by the V_1 voltage source when the output connected to that input becomes active.

Switching Load Configurations



- V_C logic high = 3.0V
- V_C logic low = 0V
- *C_L includes jig and probe capacitance

FIGURE 1.



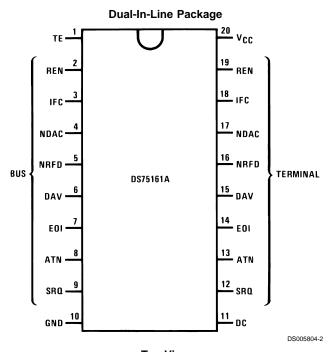
 V_C logic high = 3.0V

 V_C logic low = 0V

*C_L includes jig and probe capacitance

FIGURE 2.

Connection Diagrams



Top View

Functional Description

DS75160A

This device is an 8-channel bi-directional transceiver with one common direction control input, denoted TE. When used to implement the IEEE-488 bus, this device is connected to the eight data bus lines, designated $\text{DIO}_1-\text{DIO}_8$. The port connections to the bus lines have internal terminators, in accordance with the IEEE-488 Standard, that are deactivated when the device is powered down. This feature guarantees no bus loading when $V_{\rm CC}=0V$. The bus port outputs also have a control mode that either enables or disables the active upper stage of the totem-pole configuration. When this control input, denoted PE, is in the high state, the bus outputs operate in the high-speed totem-pole mode. When PE is in the low state, the bus outputs operate as open collector outputs which are necessary for parallel polling.

DS75161A

This device is also an 8-channel bi-directional transceiver which is specifically configured to implement the eight management signal lines of the IEEE-488 bus. This device, paired with the DS75160A, forms the complete 16-line interface between the IEEE-488 bus and a single controller instrumentation system. In compliance with the system organization of the management signal lines, the SRQ, NDAC, and NRFD bus port outputs are open collector. In contrast to the DS75160A, these open collector outputs are a fixed configuration. The direction control is divided into three groups. The DAV, NDAC, and NRFD transceiver directions are controlled by the TE input. The ATN, SRQ, REN, and IFC transceiver directions are controlled by the DC input. The EOI transceiver direction is a function of both the TE and DC inputs, as well as the logic level present on the ATN channel. The port connections to the bus lines have internal terminators identical to the DS75160A.

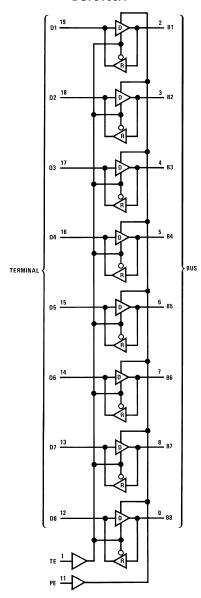
Functional Description (Continued)

Table of Signal Line Abbreviations

Signal Line	Mne-				
Classi-	monic	Definition	Device		
fication					
	DC	Direction Control	DS75161A		
Control	PE	Pull-Up Enable	DS75160A		
Signals	TE	Talk Enable	All		
	SC	System Controller			
Data	B1-B8	Bus Side of Device			
I/O Ports	D1-D8	Terminal Side	DS75160A		
		of Device			
	ATN	Attention			
	DAV	Data Valid			
	EOI	End or Identify			
Management	IFC	Interface Clear	DS75161A		
Signals	NDAC	Not Data Accepted			
	NRFD	Not Ready for Data			
	REN	Remote Enable			
	SRQ	Service Request			

Logic Diagrams

DS75160A



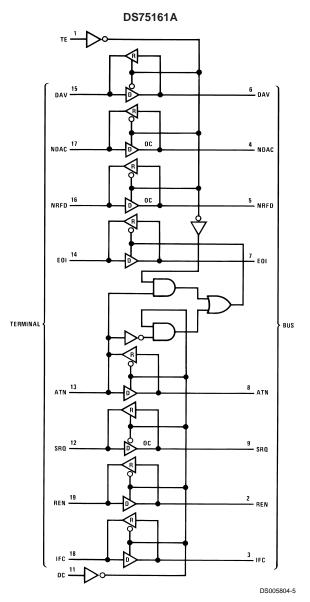
Denotes driver Note 2: — Denotes receiver

Note 3: Driver and receiver outputs are totem-pole configurations

Note 4: The driver outputs of DS75160A can have their active pull-ups
disabled by switching the PE input (pin 11) to the logic low state. This
mode configures the outputs as open collector.

DS005804-4

Logic Diagrams (Continued)



Note 1: Denotes driver

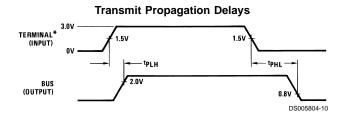
Note 2: R Denotes receiver

Note 3: Symbol "OC" specifies open collector output

Note 4: Driver and receiver outputs that are not specified "OC" are totem-pole configurations

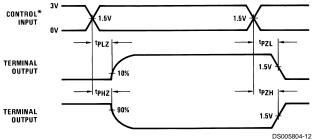
DS005804-7

Switching Waveforms

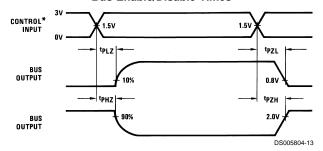


Switching Waveforms (Continued)

Terminal Enable/Disable Times



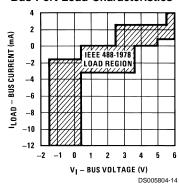
Bus Enable/Disable Times



*Input signal: f = 1.0 MHz, 50% duty cycle, t_r = $t_f \le 5$ ns

Performance Characteristics

Bus Port Load Characteristics



7

Refer to Electrical Characteristics table

Functional Truth Tables

DS75160A

	ol Input evel	Data Transceivers				
TE	PE	Direction	Bus Port Configuration			
Н	Н	Т	Totem-Pole Output			
Н	L	Т	Open Collector Output			
L	X	R	Input			

DS75161A

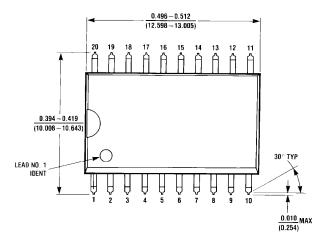
Control Input Level			Transceiver Signal Direction								
TE	DC	АТ	N*	EOI	REN	IFC	SRQ	NRFD	NDAC	DAV	
Н	Н		R		R	R	Т	R	R	Т	
Н	L		Т		Т	Т	R	R	R	Т	
L	Н		R		R	R	Т	Т	Т	R	
L	L		Т		Т	Т	R	Т	Т	R	
Н	Х	Н		Т							
L	Х	Н		R							
X	Н	L		R							
Х	L	L		Т							

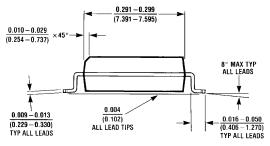
H = High level input

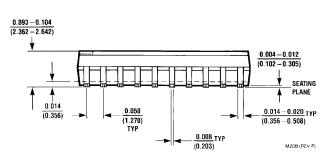
L = Low level input X = Don't care

T = Transmit, i.e., signal outputted to bus
R = Receive, i.e., signal outputted to terminal
*The ATN signal level is sensed for internal multiplex control of EOI transmission direction logic.

Physical Dimensions inches (millimeters) unless otherwise noted

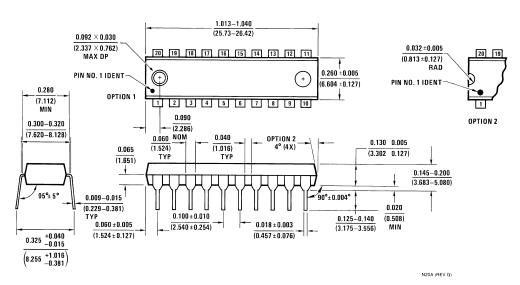






Order Number DS75160AWM NS Package Number M20B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Molded Dual-In-Line Package (N) Order Number DS75160AN or DS75161AN **NS Package Number N20A**

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